

B320A - B360A

3.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Product Summary

B320A-B340A:							
V _{RRM} (V)	l _O (A)	V _{F(MAX)} @ 3A (V)	I _{R(MAX)} @ V _{RRM} (mA)				
20, 30, 40	3.0	0.50	0.5				

B350-B360A:

V _{RRM} (V)	l _O (A)	V _{F(typ)} @ 125°C (V)	I _{R(MAX)} @ V _{RRM} (mA)
50, 60	3.0	0.70	0.5

Description and Applications

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

Case: SMA

- Case Material: Molded Plastic. "Green" Molding compound. UL Flammability Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208⁽²³⁾
- Polarity: Cathode Band
- Weight: 0.064 grams (approximate)

SMA



Ordering Information (Note 5)

-			
Part Number*	Compliance	Case	Packaging
B3XXA-13-F	Standard	SMA	5000/Tape & Reel

* xx = Device type, e.g. B320A-13-F (SMA package).

Notes:

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Product manufactured with Date Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information (Note 6)



B3x0A = Product type marking code, ex: B320A)'| = Manufacturers' code marking YWW = Date code marking Y = Last digit of year (ex: 13 for 2013) WW = Week code (01 to 53)

Note: 6. Device has a cathode band (as shown above) and may also have a cathode notch.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.							
Characteristic	Symb	ol B320A	B330A	B340A	B350A	B360A	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWI} V _R		30	40	50	60	V
Average Rectified Output Current @ T _T = +100°C			3.0				
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load				80			А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Total Power Dissipation - Steady State , TA = +25°C (Note 7)	PD	850	mW
Typical Thermal Resistance, Junction to Ambient (Note 7)	R _{0JA}	140	°C/W
Typical Thermal Resistance, Junction to Terminal (Note 8)	R _{θJT}	25	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 8)	R _{0JA}	100	°C/W
Operating Temperature Range	TJ	-55 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

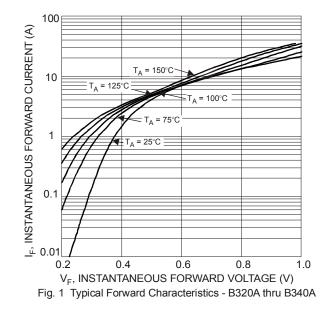
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
Forward Voltage Drop	B320A, B330A, B340A	V		-	0.50	V	I _F = 3.0A, T _A = +25°C	
Forward Voltage Drop	B350A, B360A	V _F	_	_	0.70	v		
Leakage Current (Note 9)		I _R			0.5	- mA	@ Rated V _R , T _A = +25°C	
			_	_	20		@ Rated V _R , T _A = +100°C	
Total Capacitance		CT		200		pF	V _R = 4V, f = 1MHz	

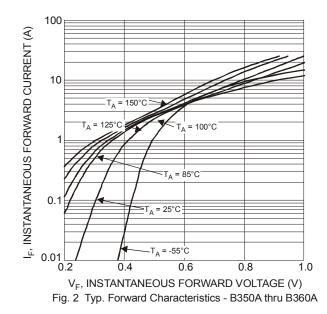
Notes:

7. Device mounted on FR-4 PCB, with minimum recommended pad layout

8. Device mounted on glass epoxy substrate with 2x3mm copper pad.

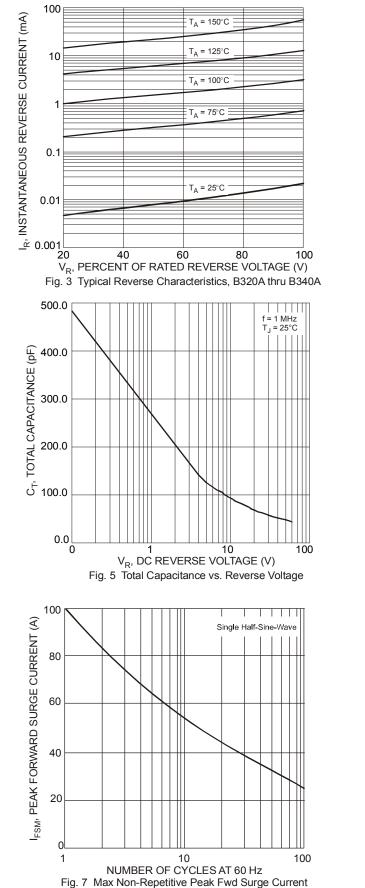
9. Short duration pulse test used to minimize self-heating effect.

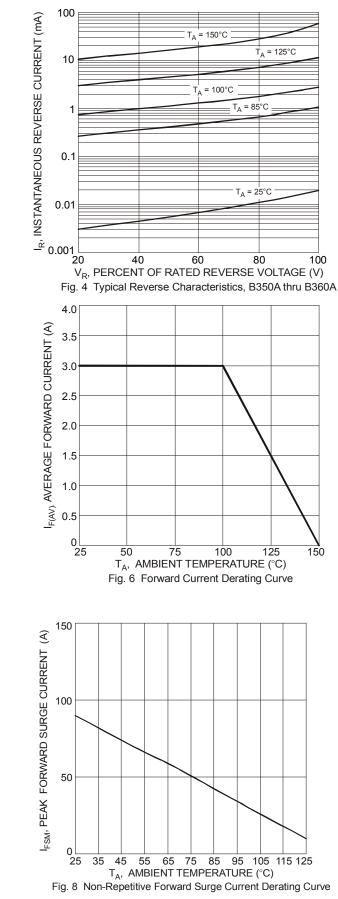




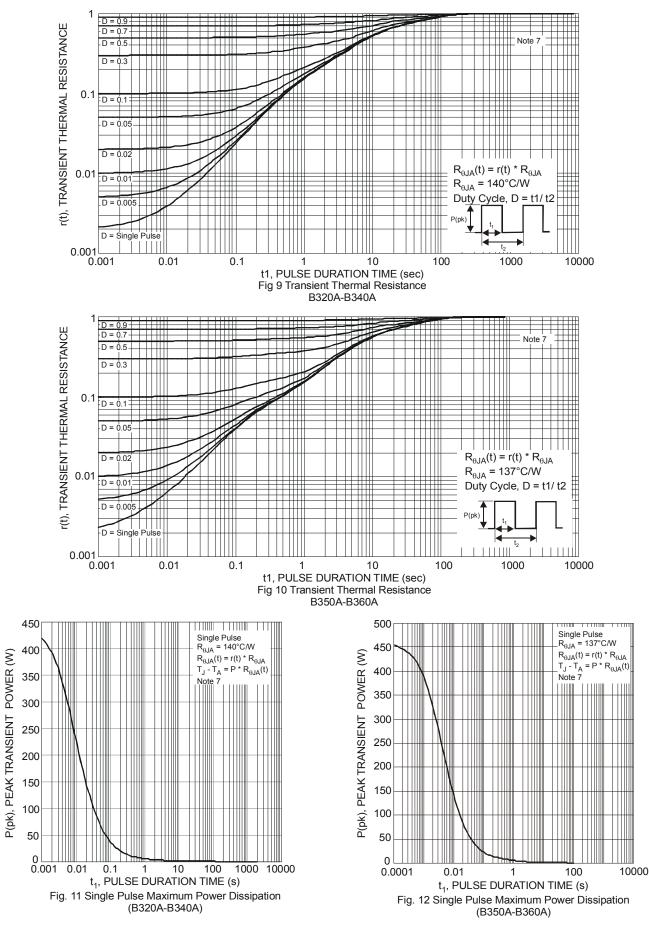








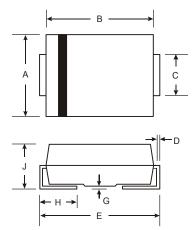






Package Outline Dimensions

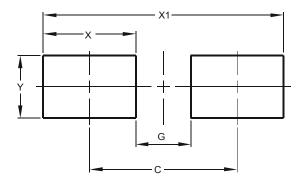
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SMA					
Dim	Dim Min Max				
Α	2.29	2.92			
в	4.00	4.60			
С	1.27	1.63			
D	0.15	0.31			
ш	4.80	5.59			
G	0.05	0.20			
н	0.76	1.52			
J	2.01	2.30			
All Dim	All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Y	1.70



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